OSRAM LE BR Q7WM.03 **Datasheet**

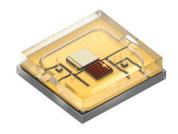




OSRAM OSTAR® Projection Compact

LE BR Q7WM.03

Compact light source in SMT technology, glass window on top, RoHS compliant





Applications

- Projection & Display

- Visualization

Features

- Package: compact lightsource in SMT technology with glass window on top
- Chip technology: Thinfilm / UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: λ_{dom} = 456 nm (• blue); λ_{dom} = 617 nm (• red)
- Corrosion Robustness Class: 3B
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)



Ordering Information

ordonnig in		
Туре	Brightness 1)	Ordering Code
LE BR Q7WM.0	03-VHAX-23+LXLZ-23	Q65113A5494
• blue	• Φ_E = 820 1300 mW (I_F = 750 mA)	
• red	• Φ_{V} = 112 180 lm (I_{F} = 750 mA)	



Maximum	Ratings
---------	---------

Parameter	Symbol		Values ● blue	Values • red
Operating Temperature	T _{op}	min.	-40 °C	-40 °C
	Оρ	max.	110 °C	110 °C
Storage Temperature	T _{stg}	min.	-40 °C	-40 °C
	sig	max.	110 °C	110 °C
Junction Temperature	T _i	max.	125 °C	125 °C
Forward Current	I _F	min.	50 mA	50 mA
$T_j = T_{j \text{ max.}}$	'	max.	750 mA	750 mA
Forward Current pulsed f = 240Hz; D = 0.5; T _i = T _{imax}	 F pulse		1650 mA	1650 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM)	$V_{\scriptscriptstyle{ESD}}$		2 kV	2 kV
Reverse current 2)	I _R	max.	200 mA	200 mA



Characteristics

 $I_F = 750 \text{ mA}; T_S = 25 \text{ }^{\circ}\text{C}$

Parameter	Symbol		Values • blue	Values • red
Peak Wavelength	λ_{peak}	typ.	450 nm	624 nm
Dominant Wavelength 3)	$\lambda_{\sf dom}$	min.	452 nm	610 nm
	20	typ.	456 nm	617 nm
		max.	460 nm	622 nm
Spectral bandwidth at 50% I _{rel,max}	Δλ	typ.	19 nm	18 nm
Viewing angle at 50% $\rm I_{\rm V}$	2φ	typ.	120 °	120 °
Radiating surface	A_{color}	typ.	0.73 x 0.73 mm²	0.7 x 0.7 mm ²
Partial Flux acc. CIE 127:2007 ⁴⁾ $\Phi_{E/V 120^{\circ}} = x * \Phi_{E/V 180^{\circ}}$	Φ _{E/V, 120°}	typ.	0.82	0.76
Forward Voltage 5)	V _F	min.	2.80 V	2.30 V
I _F = 750 mA	•	typ.	3.15 V	2.60 V
		max.	3.40 V	3.00 V
Reverse voltage (ESD device)	$V_{\text{R ESD}}$	min.	45 V	45 V
Reverse voltage ²⁾ I _R = 20 mA	V_R	max.	1.2 V	1.2 V
Real thermal resistance junction/solderpoint ⁶⁾ 1 Chip on	R _{thJS real}	typ.	6.0 K / W	6.0 K / W
Electrical thermal resistance junction/solderpoint 1 Chip on with efficiency ηe = 40 % (blue); 25 % (red)	R _{thJS elec.}	typ.	3.6 K / W	4.5 K / W



Brightness Groups

• blue

Group	Radiant Flux ¹⁾ $I_F = 750 \text{ mA}$ min. Φ_E	Radiant Flux ¹⁾ $I_F = 750 \text{ mA}$ $max.$ Φ_E	
VH	820 mW	970 mW	
VI	970 mW	1120 mW	
AX	1120 mW	1300 mW	

Brightness Groups

• red

Group	Luminous Flux ¹⁾ $I_F = 750 \text{ mA}$ min. Φ_V	Luminous Flux ¹⁾ $I_F = 750 \text{ mA}$ max. Φ_V	
LX	112 lm	130 lm	
LY	130 lm	150 lm	
LZ	150 lm	180 lm	



Wavelength Groups

• blue

Group	Dominant Wavelength 3)	Dominant Wavelength 3)
	min.	max.
	$\lambda_{\sf dom}$	$\lambda_{\sf dom}$
2	452 nm	456 nm
3	456 nm	460 nm

Wavelength Groups

• red

Group Dominant Wavelength 3)		Dominant Wavelength 3)	
	min.	max.	
	λ_{dom}	λ_{dom}	
2	610 nm	616 nm	
3	616 nm	622 nm	

Group Name on Label

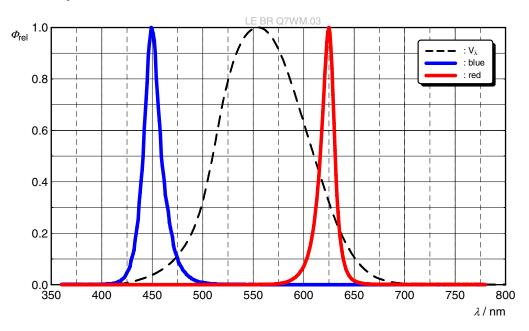
Example: LX-2+AX-2

Color	Brightness	Wavelength
• blue	AX	2
• red	LX	2



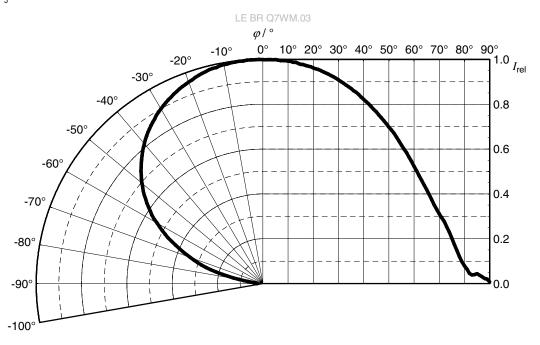
Relative Spectral Emission 4)

$$\Phi_{rel}$$
 = f (λ); I_F = 750 mA; T_J = 25 °C



Radiation Characteristics 4)

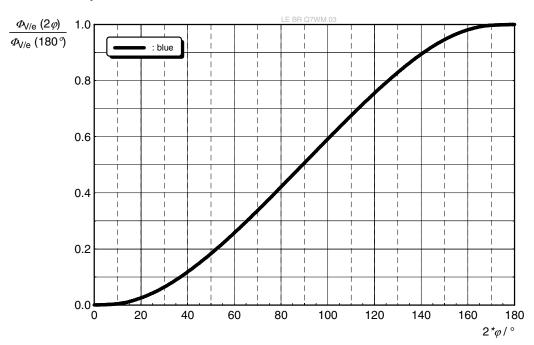
$$I_{rel} = f(\phi); T_J = 25 \, ^{\circ}C$$





Relative Partial Flux 4)

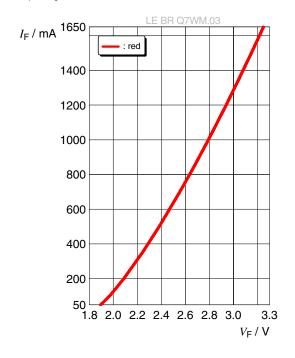
 $\Phi_{_{\text{V/E}}}(2\phi)/\Phi_{_{\text{V/E}}}(180^\circ) = f(\phi); \, T_{_J} = 25 \,\, ^\circ C$





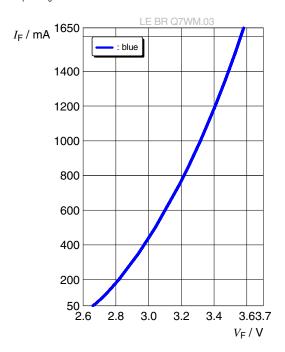
Forward current 4)

$$I_F = f(V_F); T_J = 25 °C$$



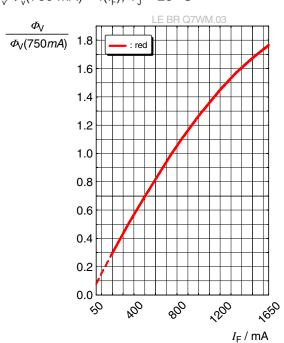
Forward current 4)

$$I_{F} = f(V_{F}); T_{J} = 25 \, ^{\circ}C$$



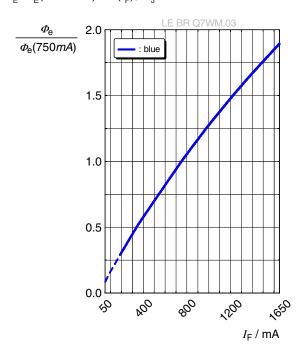
Relative Luminous Flux 4), 7)

$$\Phi_{V}/\Phi_{V}(750 \text{ mA}) = f(I_{F}); T_{J} = 25 \text{ °C}$$



Relative Radiant Power 4), 7)

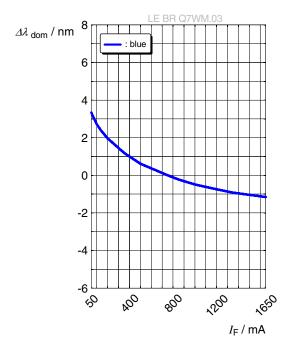
$$\Phi_{\rm F}/\Phi_{\rm F}(750 \text{ mA}) = f(I_{\rm F}); T_{\rm J} = 25 \, ^{\circ}{\rm C}$$





Dominant Wavelength 4)

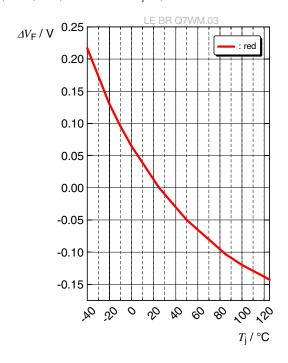
$$\Delta\lambda_{dom} = f(I_F); T_J = 25 \text{ }^{\circ}\text{C}$$



OSRAM

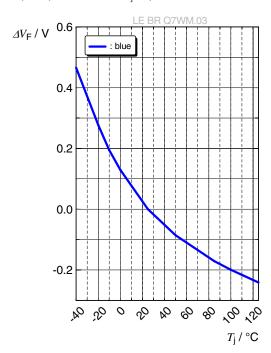
Forward Voltage 4)

$$\Delta V_{F} = V_{F} - V_{F}(25 \text{ °C}) = f(T_{i}); I_{F} = 750 \text{ mA}$$



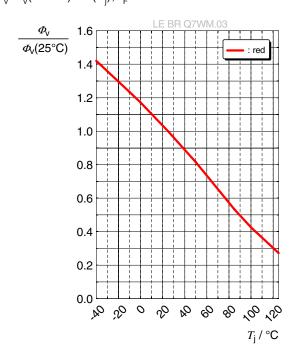
Forward Voltage 4)

$$\Delta V_F = V_F - V_F (25 \text{ °C}) = f(T_i); I_F = 750 \text{ mA}$$



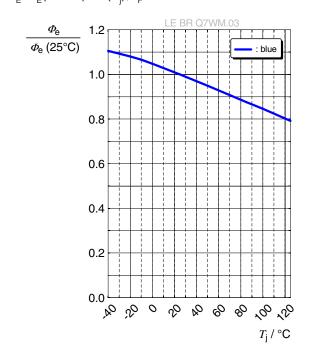
Relative Luminous Flux 4)

$$\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 750 \text{ mA}$$



Relative Radiant Power 4)

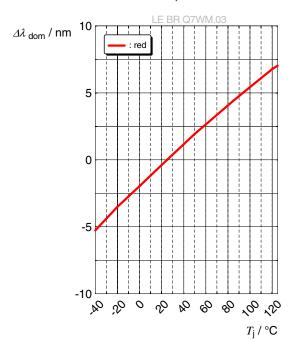
$$\Phi_{\rm F}/\Phi_{\rm F}(25~{\rm ^{\circ}C}) = f(T_{\rm i}); I_{\rm F} = 750~{\rm mA}$$





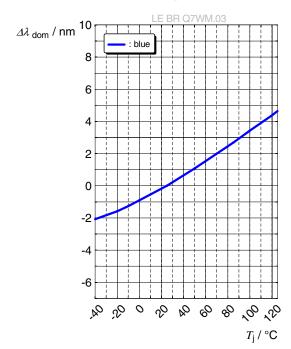
Dominant Wavelength 4)

$$\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom} (25 \text{ °C}) = f(T_j); I_F = 750 \text{ mA}$$



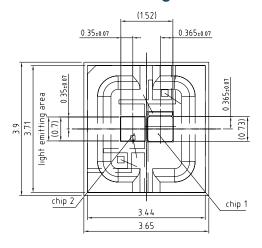
Dominant Wavelength 4)

$$\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom} (25 \text{ °C}) = f(T_j); I_F = 750 \text{ mA}$$

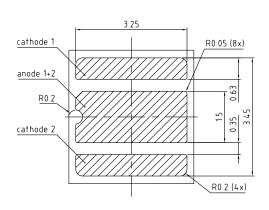




Dimensional Drawing 8)







general tolerance ±0.1 lead finish Au

C67062-A0437-A1-07

Further Information:

Approximate Weight: 36.0 mg

Corrosion test: Class: 3B

Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC

60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the

Chip.



Electrical Internal Circuit

Pin Assignment:

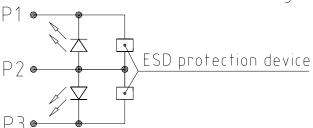
P1: cathode chip 1

P2 : anode chip 1 + chip 2

P3: cathode chip 2

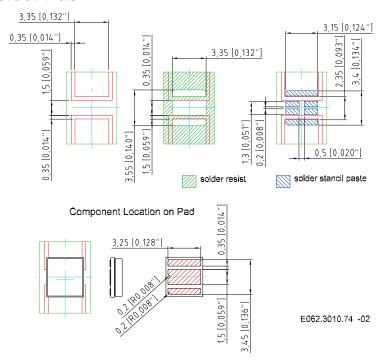
Chip 1: Blue Chip 2 : Red

Electrical Internal Circuit and Pin Assignment





Recommended Solder Pad 8)

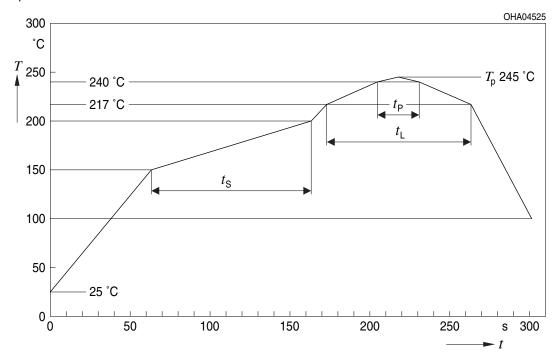


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for any kind of wet cleaning or ultrasonic cleaning.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



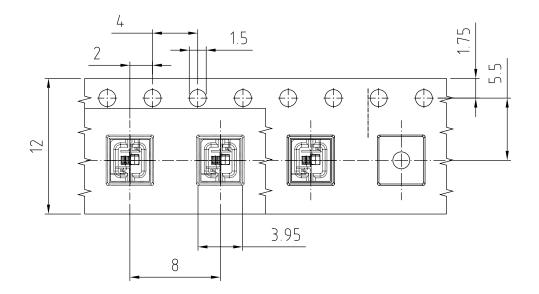
Symbol	Symbol Pb-Free (SnAgCu) Ass			Unit
	Minimum	Recommendation	Maximum	
'		2	3	K/s
t _s	60	100	120	S
		2	3	K/s
T_{L}		217		°C
$t_{\scriptscriptstyle \perp}$		80	100	S
T_{P}		245	260	°C
t _P	10	20	30	S
		3	6	K/s
		-	-	
			480	S
	t _s T _L t _L T _P	Minimum t _s 60 T _L t _L T _P	$\begin{array}{c cccc} & Minimum & Recommendation \\ & & 2 \\ \hline t_s & 60 & 100 \\ & & 2 \\ \hline T_L & & 217 \\ t_L & & 80 \\ \hline T_P & & 245 \\ t_P & 10 & 20 \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

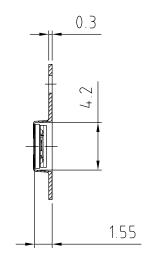
All temperatures refer to the center of the package, measured on the top of the component

^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



Taping 8)

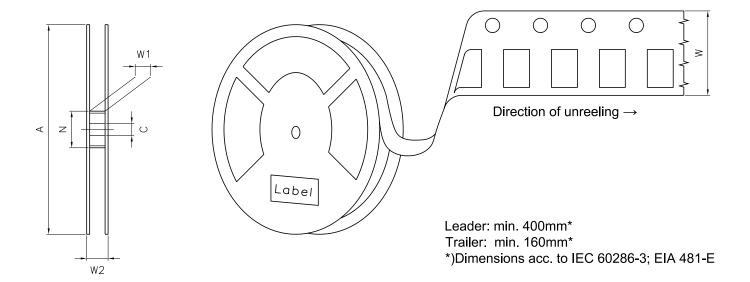




C67062-A0437-B2-02



Tape and Reel 9)

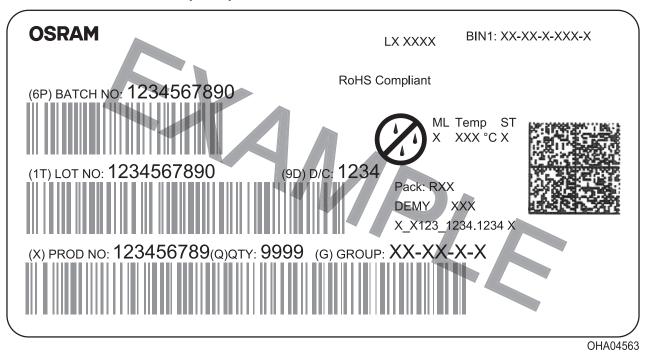


Reel Dimensions

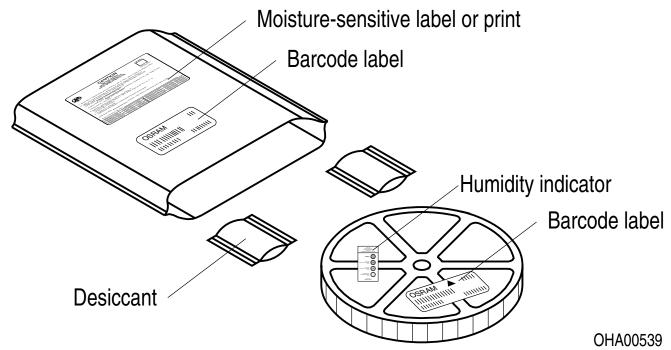
Α	W	N_{\min}	W_1	$W_{2 \text{max}}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	500



Barcode-Product-Label (BPL)



Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class moderate risk (exposure time 0.25 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 5) Forward Voltage: Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of k = 3).
- 6) Thermal Resistance: Rth max is based on statistic values (6σ) used for Derating.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- 9) Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision History				
Version	Date	Change		
1.0	2023-11-28	Electro - Optical Characteristics (Diagrams) Product Image Characteristics Maximum Ratings		
1.1	2023-12-28	Dimensional Drawing Characteristics		



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

Published by ams-OSRAM AG

Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved





Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ams OSRAM:

LE BR Q7WM.0A-VHAY-23-0+LXMX-23-0